

Chip Card & Security

SLE 4406SP SLE 4406SPE

Intelligent 112–Bit EEPROM Counter for > 20000 Units with Security Logic

Short Product Information

October 2008

SLE 4406SP/06SPE Short Product Information Ref.: SPI_SLE4406SP_1008.0				
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	Editorial update			

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Infineon Technologies is an approved CECC manufacturer.

Information

For further information on technology, delivery terms and conditions and prices please contact your nearest Infineon Technologies Office in Germany or our Infineon Technologies Representatives world-wide (see address list).

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Intelligent 112–Bit EEPROM Counter for > 20000 Units with Security Logic

Features

• 100% functional compatibility to 4406S/06SE

• 112 bit EEPROM and 16 bit ROM

- 104 bit user memory fully compatible with SLE 4406/06E
- -64 bit Identification Area 1 consisting of
 - 16 bit Manufacturer code
 - SLE 4406SP:
 - 8 bit Manufacturer data, card issuer dependent
 - 40 bit for personalization data of card issuer
 - SLE 4406SPE:
 - 48 bit for personalization data of card issuer
- -40 bit Counter Area including 1 bit for personalization (PROM/EEPROM)

24 bit additional memory for advanced features configurable during personalization – either 24 bit Identification Area 2 for personalization data of card issuer – or 24 bit Data Area for free user access

• Counter with up to 33352 count units

- Five stage abacus counter
- Due to testing purposes a maximum of 21064 count units is guaranteed
- Transport Code protection for delivery
- Contact configuration and Answer-to-Reset (synchronous transmission) in accordance to standard ISO/IEC 7816

• Sophisticated electrical characteristics

- Ambient temperature T_A –40 … +80°C for chip
- Supply voltage 5 V ± 10 %
- Supply current < 1 mA
- EEPROM programming time 5 ms
- ESD protection minimum 2,000 V, typical 4,000 V
- Endurance minimum 100,000 write/erase cycles / bit¹⁾
- Data retention for minimum of 30 years¹⁾

• Advanced 1.2 µm CMOS-technology optimised for security layout

- EEPROM-cells protected by shield
- Secure wiring for all security relevant signals
- Shielding of deeper layers via metal
- Sensory and logical security functions
- No isolation on backside necessary



¹⁾ Values are temperature dependent



Table 1Ordering Information

Туре	Package ¹⁾	Remark	Access of 3rd byte	
SLE 4406SP C	Die (on Wafer)	unsawn		
SLE 4406SP D	Die (on Wafer)	sawn	Data of 3rd byte are programmed by Infineon exclusively	
SLE 4406SP M3	T-M3.2-6			
SLE 4406SP MFC3	S-MFC3.1-6-1	FCoS ^{™ 2)}	-	
SLE 4406SPE C	Die (on Wafer)	unsawn		
SLE 4406SPE D	Die (on Wafer)	sawn	Data of 3rd byte are programmed by the	
SLE 4406SPE M3	T-M3.2-6		card manufacturer at personalisation	
SLE 4406SPE MFC3	S-MFC3.1-6-1	FCoS ^{™ 2)}		

Pin Description



Figure 1 Pin Configuration Wire-bonded Module M3.2 (top view)



Figure 2 Pin Configuration Flip Chip Module MFC3.1 (top view)

¹⁾ Available as a Flip Chip Module (MFC3), wire-bonded module (M3) for embedding in plastic cards or as a die on unsawn (C) / sawn wafer (D) for customer packaging

²⁾ FCoS[™] Flip Chip on Substrate





Figure 3 Pad Configuration Die

Table 2Pin Definitions and Functions	
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Card Contact	Symbol	Function
C1	VCC	Supply voltage
C2	RST	Control input (Reset Signal)
C3	CLK	Clock input
C5	GND	Ground
C6	N.C.	Not connected
C7	I/O	Bi-directional data line (open drain)



General Description

SLE 4406SP/06SPE is designed for applications in prepaid telephone cards. The chip consists of an EEPROM memory of 112 bit, a ROM of 16 bits and a control/security unit.



Figure 4 Block Diagram

Memory Unit

Counter, Identification Data (e.g. serial number, expiry date) and Data Area.

Address Unit

Setting of the address counter is synchronously with the CLK.

- **Programming Unit** The programming voltage for the EEPROM/PROM is generated internally.
- Security Interface Ensures a minimum and a maximum frequency and proper logical voltage levels.